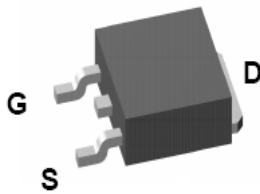


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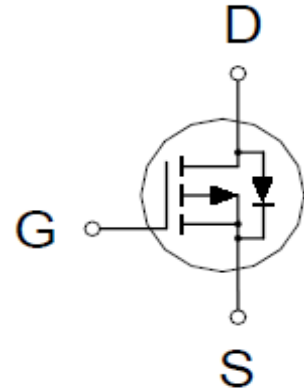
P-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
-40V	14mΩ @ $V_{GS} = -10V$	-51A



TO-252



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	-40	V
Gate-Source Voltage		V_{GS}	±25	V
Continuous Drain Current ²	$T_C = 25\text{ }^{\circ}\text{C}$	I_D	-51	A
	$T_C = 100\text{ }^{\circ}\text{C}$		-40	
Pulsed Drain Current ¹		I_{DM}	-150	
Avalanche Current		I_{AS}	-38	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	72.2	mJ
Power Dissipation	$T_C = 25\text{ }^{\circ}\text{C}$	P_D	65	W
	$T_C = 100\text{ }^{\circ}\text{C}$		42	
Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	$^{\circ}\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		1.9	$^{\circ}\text{C} / \text{W}$
Junction-to-Ambient	$R_{\theta JA}$		62.5	

¹Pulse width limited by maximum junction temperature.

²Package limitation current is -40A.

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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-40			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-1	-1.8	-3	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 25V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -32V, V_{GS} = 0V$			-1	μA
		$V_{DS} = -30V, V_{GS} = 0V, T_J = 125^{\circ}C$			-10	
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = -4.5V, I_D = -15A$		14	20	m Ω
		$V_{GS} = -10V, I_D = -20A$		10	14	
Forward Transconductance ¹	g_{fs}	$V_{DS} = -5V, I_D = -20A$		50		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = -20V, f = 1MHz$		2670		pF
Output Capacitance	C_{oss}			313		
Reverse Transfer Capacitance	C_{rss}			222		
Gate Resistance	R_g	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$		4.5		Ω
Total Gate Charge ²	$Q_g(V_{GS} = -10V)$	$V_{DS} = -20V, I_D = -20A$		58		nC
	$Q_g(V_{GS} = -4.5V)$			29		
Gate-Source Charge ²	Q_{gs}			9		
Gate-Drain Charge ²	Q_{gd}			14		
Turn-On Delay Time ²	$t_{d(on)}$	$V_{DS} = -20V, I_D \cong -20A,$ $V_{GS} = -10V, R_{GEN} = 6\Omega$		29		nS
Rise Time ²	t_r			20		
Turn-Off Delay Time ²	$t_{d(off)}$			90		
Fall Time ²	t_f			41		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^{\circ}C$)						
Continuous Current ³	I_S				-50	A
Forward Voltage ¹	V_{SD}	$I_F = -20A, V_{GS} = 0V$			-1.3	V
Reverse Recovery Time	t_{rr}	$I_F = -20A, dI_F/dt = 100A/\mu S$		17		nS
Reverse Recovery Charge	Q_{rr}			6		nC

¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.

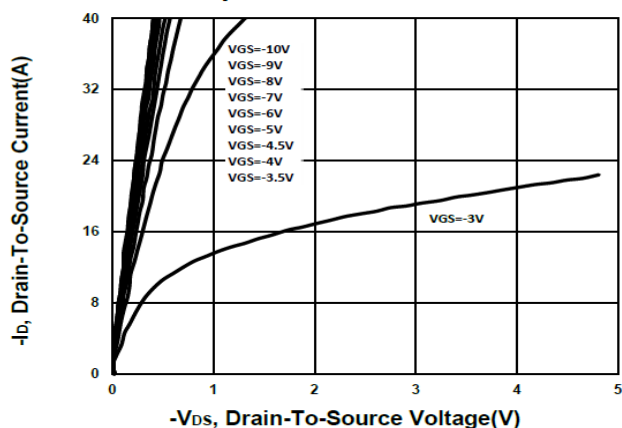
²Independent of operating temperature.

³Package limitation current is -40A.

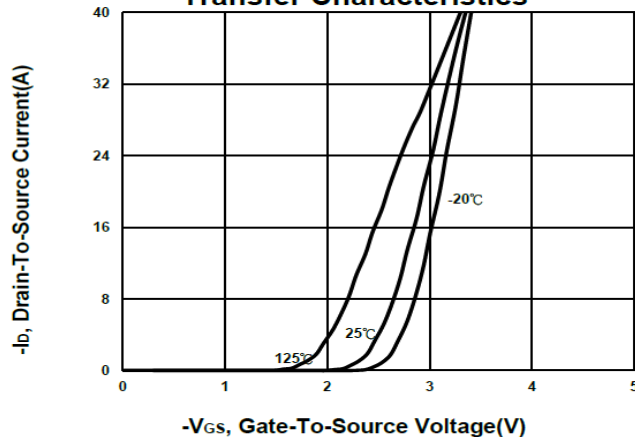
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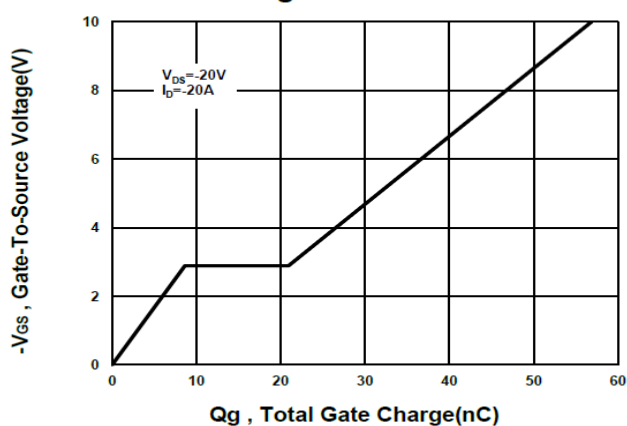
Output Characteristics



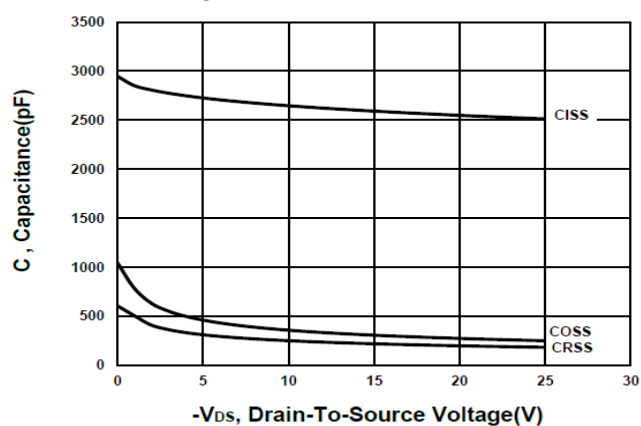
Transfer Characteristics



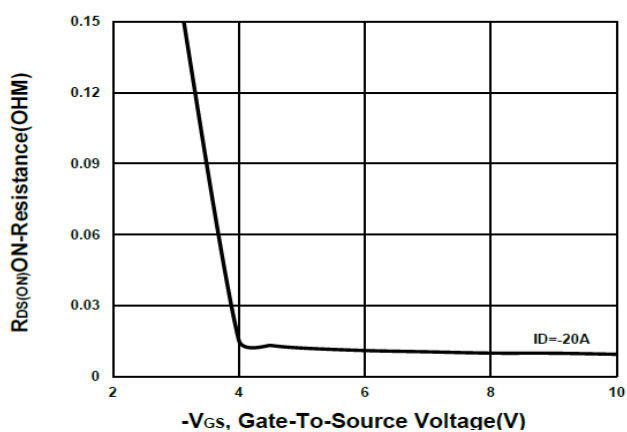
Gate charge Characteristics



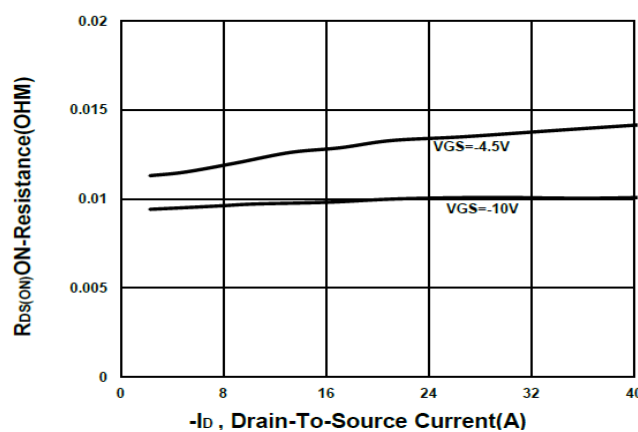
Capacitance Characteristic



On-Resistance VS Gate-To-Source



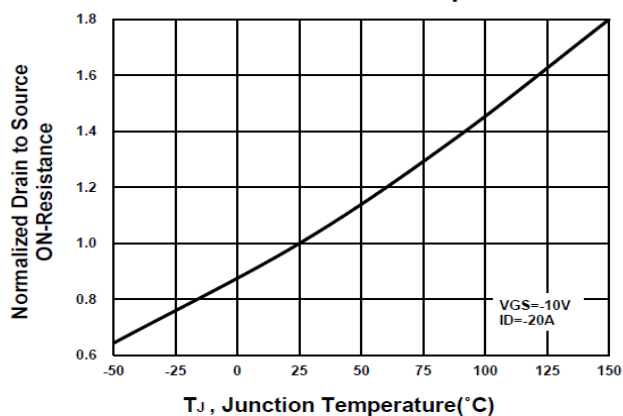
On-Resistance VS Drain Current



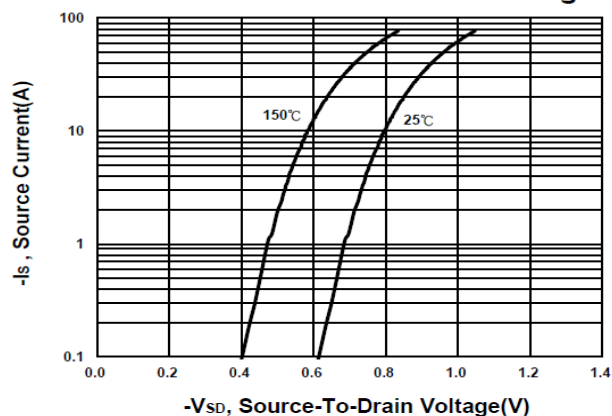
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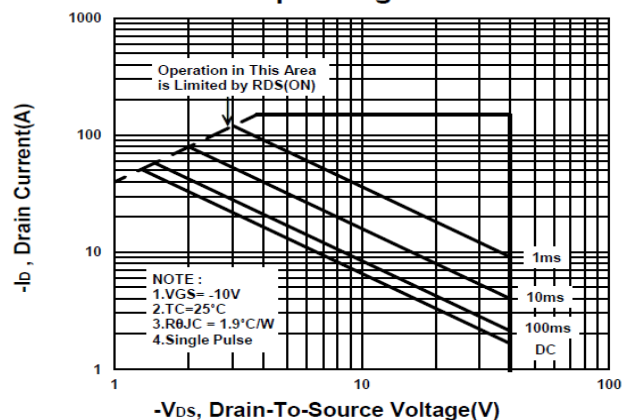
On-Resistance VS Temperature



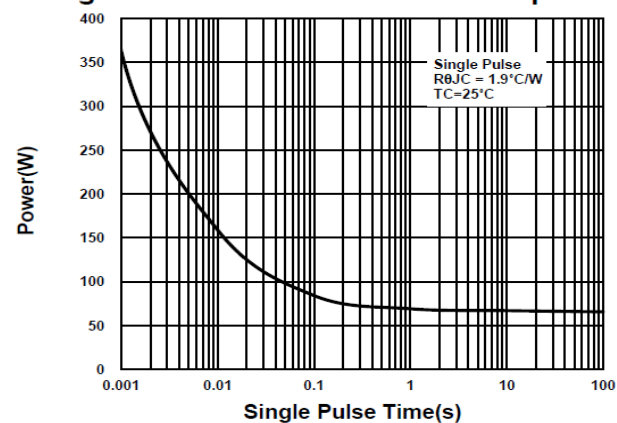
Source-Drain Diode Forward Voltage



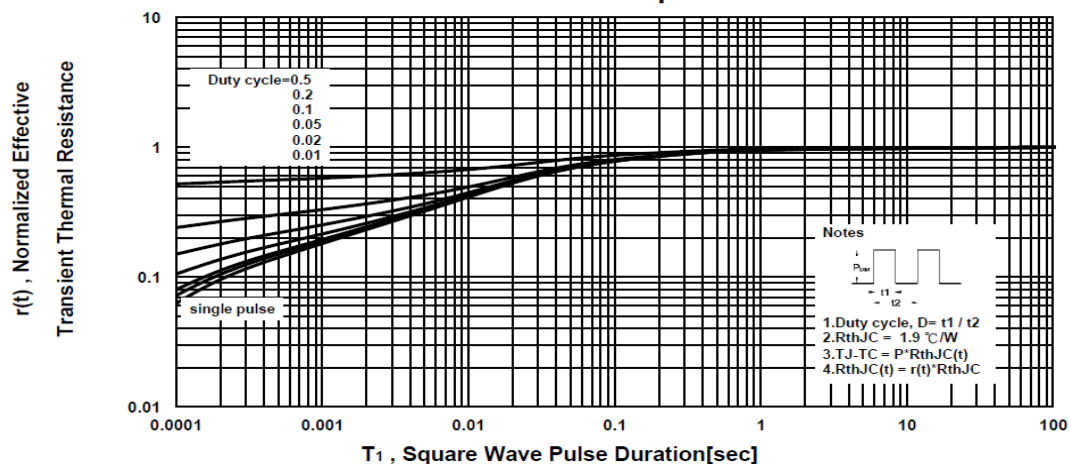
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



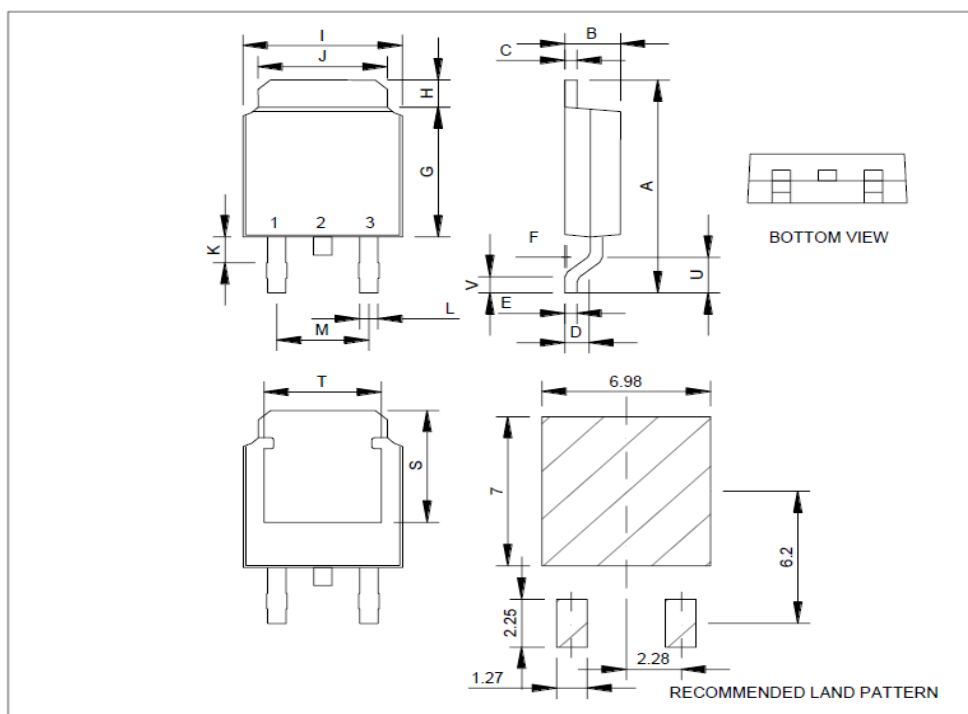
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P-Channel Enhancement Mode MOSFET

Package Dimension

TO-252 (DPAK) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	8.9	10	10.41	J	4.8		5.64
B	2.1	2.2	2.4	K	0.15		1.1
C	0.4	0.5	0.61	L	0.4	0.76	0.89
D	0.82	1.2	1.5	M	4.2	4.58	5
E	0.4	0.5	0.61	S	4.9	5.1	5.3
F	0		0.2	T	4.6	4.75	5.44
G	5.3	6.1	6.3	U	1.4		1.78
H	0.9		1.7	V	0.55	1.25	1.7
I	6.3	6.5	6.8				



*因为各家封装模具不同而外观略有所差异，不影响电性及Layout。